

OCT 27 2003
SC37

IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Peter M. Martino

Confirmation No.:

Application No.: 10/652,847

Examiner:

Filing Date: 08/29/2003

Group Art Unit:

Title: SUBSTRATE REINFORCING IN AN LGA PACKAGE

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

This Information Disclosure Statement is submitted:

- (X) under 37 CFR 1.97(b), or
(Within three months of filing national application; or date of entry of national application; or before mailing date of first office action on the merits; whichever occurs last)
- () under 37 CFR 1.97 (c) together with either a:
() Statement under 37 CFR 1.97(e), or
() a \$180.00 fee under 37 CFR 1.17(p), or
(After the CFR 1.97 (b) time period, but before final action or notice of allowance, whichever occurs first)
- () under 37 CFR 1.97 (d) together with a:
() Statement under 37 CFR 1.97(e)(1) or (2), and
() a \$180.00 fee set forth in 37 CFR 1.17(p).
(Filed after final action, a notice of allowance, on or before payment of the issue fee)

Please charge to Deposit Account **08-2025** the sum of \$0.00. At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account **08-2025** pursuant to 37 CFR 1.25.

(X) Applicant(s) submit herewith Form PTO 1449 - Information Disclosure Statement together with any required copies of patents, publications or other information of which applicant(s) are aware, which applicant(s) believe(s) may be material to the examination of this application and for which there may be a duty to disclose in accordance with 37 CFR 1.56.

() A concise explanation of the relevance of foreign language patents, foreign language publications and other foreign language information listed on PTO Form 1449, as presently understood by the individual(s) designated in 37 CFR 1.56 (c) most knowledgeable about the content is given on the attached sheet, or where a foreign language patent is cited in a search report or other action by a foreign patent office in a counterpart foreign application, an English language version of the search report or action which indicates the degree of relevance found by the foreign office is listed on form PTO 1449 and is enclosed herewith.

It is requested that the information disclosed herein be made of record in this application.

(X) I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450. Date of Deposit: 10/22/2003
OR

Respectfully submitted,

Peter M. Martino

By

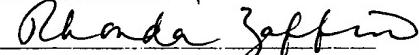


Adam E. Crall

Attorney/Agent for Applicant(s)
Reg. No. **46,646**

Date: **10/22/2003**

Typed Name: **Rhonda Zaffino**

Signature: 

FORM PTO-1449

OCT 27 2003

LIST OF PATENTS AND PUBLICATIONS FOR
APPLICANT'S INFORMATION DISCLOSURE
STATEMENT

(Use several sheets if necessary)

ATTY. DOCKET NO.	APPLICATION NO.	CONFIRMATION NO.
200309657-1	10/652,847	
APPLICANT		
Peter M. Martino		
FILING DATE	GROUP	
08/29/2003		

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	PUBLICATION DATE	NAME	Pages, Columns, Lines Where Relevant Passages or Figures Appear
1A	6,596,561	7/22/2003	Takahashi et al.	
1B	6,583,040	6/24/2003	Lin	
1C	6,531,947	3/11/2003	Weaver et al.	
1D	6,529,023	3/4/2003	Becker et al.	
1E	6,528,892	3/4/2003	Caketka et al.	
1F	6,490,161	12/3/2002	Johnson	
1G	6,477,058	11/5/2002	Luebs et al.	
1H	6,384,487	5/7/2002	Smith	
1I	6,333,460	12/25/2001	Toy et al.	
1J	6,320,267	11/20/2001	Yukawa	
1K	6,312,791	11/6/2001	Fasano et al.	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	PUBLICATION DATE	NAME OF PATENTEE OR APPLICANT	Pages/Columns/Lines Where Relevant Passages/Figures Appear	Check if Translation attached
	1L					
	1M					
	1N					
	1O					
	1P					

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

1Q	Greenzweig, Yuval, "Micro-Surgery of C4 Microprocessors and Future Developments," Intel Corporation, MTM, Haifa, Israel (2 pages). <input checked="" type="checkbox"/>
1R	IBM Corporation, "Flip-chip packaging services," Hopewell Junction, New York, April 2003 (4 pages). <input checked="" type="checkbox"/>
1S	IBM Corporation, "Multilayer ceramic (MLC) packaging," Hopewell Junction, New York, April 2003 (4 pages). <input checked="" type="checkbox"/>

EXAMINER

DATE CONSIDERED

FORM PTO-1449

OCT 27 2003
U.S. PATENT AND TRADEMARK OFFICE
JC31LIST OF PATENTS AND PUBLICATIONS FOR
APPLICANT'S INFORMATION DISCLOSURE
STATEMENT

(Use several sheets if necessary)

ATTY. DOCKET NO.	APPLICATION NO.	CONFIRMATION NO.
200309657-1	10/652,847	
APPLICANT	Peter M. Martino	
FILING DATE	GROUP 08/29/2003	

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	PUBLICATION DATE	NAME	Pages, Columns, Lines Where Relevant Passages or Figures Appear
2A	6,222,263	4/24/2001	Sherif et al.	
2B	6,191,480	2/20/2001	Kastberg et al.	
2C	6,113,399	9/5/2000	Hundt et al.	
2D	5,677,247	10/14/1997	Hundt et al.	
2E	5,650,593	7/22/1997	McMillan et al.	
2F	5,413,489	5/9/1995	Switky	
2G				
2H				
2I				
2J				
2K				

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	PUBLICATION DATE	NAME OF PATENTEE OR APPLICANT	Pages/Columns/Lines Where Relevant Passages/Figures Appear	Check if Translation attached
2L					
2M					
2N					
2O					
2P					

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

2Q	Intel, "Chip Scale Pack for Intel Flash Memory Devices - Packaging Overview," http://www.intel.com/design/flcomp/PRODBREF/298113.htm (visited August 13, 2003) (4 pages). ✓
2R	Intel, "Semiconductor Technology and Manufacturing," http://www.intel.com/technology/itj/2002/volume06issue02/art07_emergingdirections/p06... (visited August 13, 2003) (3 pages). ✓
2S	Mahajan, Ravi, Raj Nair, Vijay Wakharkar, Johanna Swan, John Tang, Gilroy Vandentop, "Emerging Directions for Packaging Technologies," <u>Intel Technology Journal</u> , Vol. 6, Issue 02, May 16, 2002 (pages 62-75).

EXAMINER

DATE CONSIDERED

FORM PTO-1449

OCT 27 2003

LIST OF PATENTS AND PUBLICATIONS FOR
APPLICANT'S INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

ATTY. DOCKET NO.

200309657-1

APPLICATION NO.

10/652,847

CONFIRMATION NO.

APPLICANT

Peter M. Martino

FILING DATE

08/29/2003

GROUP

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	PUBLICATION DATE	NAME	Pages, Columns, Lines Where Relevant Passages or Figures Appear
3A				
3B				
3C				
3D				
3E				
3F				
3G				
3H				
3I				
3J				
3K				

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	PUBLICATION DATE	NAME OF PATENTEE OR APPLICANT	Pages/Columns/Lines Where Relevant Passages/Figures Appear	Check if Translation attached
3L					
3M					
3N					
3O					
3P					

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, etc.)

3Q	"Packaging Information - Package Reference Guide," http://www.icwave.com/technical/docs/package/guide.htm (visited August 13, 2003) (4 pages).	✓
3R	Tyco Electronics, "Metallized Particle Interconnect Applications Guide," North Attleboro, Massachusetts (pages 1-9).	✓
3S	Vicich, Brian and Sai Uppuluri, "Nonlinear Analysis Helps Design LGA Connectors," http://connectorspecifier.printthis.clickability.com/pt/cpt?action=cpt&expire=&urlID=408... (visited August 13, 2003) (4 pages).	

EXAMINER

DATE CONSIDERED